

Discription

Low capacitance bidirectional ElectroStatic Discharge (ESD) protection diode in a ultra-small and flat lead SOD-323 plastic package designed to protect one signal line from the damage caused by ESD and other transients.

III her record

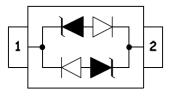
SOD-323

Features

- ★ Ultra Low Capacitance 1.0 pF(Typ)
- ★ Reverse stand-off voltage: 12V Max
- ★ Low leakage current: nA Level
- ★ Response time is typically < 1 ns
- ★ IEC61000-4-2 Level 4 ESD Protection
- ★ RoHS compliant

Applications

- ★ High- speed data lines
- ★ Smart phones
- **★** Display Ports
- **★** MDDI Ports
- **★** USB Ports
- ★ Digital Video Interface (DVI)
- ★ PCI Express and Serial SATA Ports



Circuit Diagram

Ordering Information

Product ID	Pack	Qty(PCS)		
ESDLC12VD3B	SOD-323	3000		

Absolute Ratings(Tamb = 25° C)

Parameter	Symbol	Value	Unit
Peak Pulse Power (tp = 8/20µs)	РРРМ	350	W
ESD voltage IEC 61000-4-2 (air discharge)	Vesd	30	kV
ESD voltage IEC 61000-4-2 (contact discharge)	Vesd	30	kV
Maximum lead temperature for soldering during 10s	TL	260	°C
Storage Temperature Range	Tstg	-55 to +150	°C
Operating Temperature Range	Тор	-40 to +125	°C



Electrical Characteristics

Parameter	Symbol	Min	Тур	Max	Unit	Condition
Reverse Working Voltage	Vrwm			12.0	V	
Breakdown Voltage	V _{BR}	13.3			V	I⊤=1mA
Leakage Current ILeak	lR			1.0	uA	V _{RWM} =5V
Clamping Voltage	Vc			28.6	V	Ipp=12A,Tp=8/20µs
Junction Capacitance	Сл		1.0	1.2	pF	V _R =0V, f=1MHz

Typical Characteristics

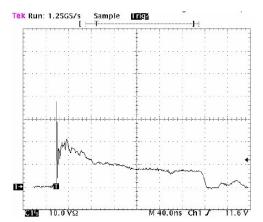


Figure 1. ESD Clamping Voltage Screenshot Positive 8 kV contact per IEC 61000-4-2

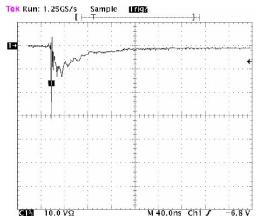
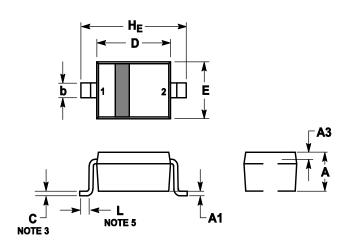


Figure 2. ESD Clamping Voltage Screenshot
Negative 8 kV contact per IEC 61000-4-2

Outline And Dimensions

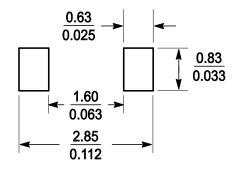


Notes:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.8	0.9	1	0.031	0.035	0.04
A1	0	0.05	0.1	0	0.002	0.004
A3	().15REI	=	0.006REF		
b	0.25	0.32	0.4	0.01	0.012	0.016
С	0.089	0.12	0.177	0.003	0.005	0.007
D	1.6	1.7	1.8	0.062	0.066	0.07
Е	1.15	1.25	1.35	0.045	0.049	0.053
L	0.08			0.003		
H _E	2.3	2.5	2.7	0.09	0.098	0.105

Soledering Footprint



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